









Release Date: 13 February 2025 Version: A1.1

PRODUCT DATASHEET



- ► EMC SMD
- ➤ 3030 0.65t Series
- ► W/R/G/B 4-in-1

N0M62S11











APPLICATIONS:

- **Decorative Lighting**
- Portable Lighting
- **Outdoor Lighting**
- **Commercial Lighting**
- **Architectural Lighting**
- Home Appliance
- Led Torch
- Mini Projector

- Package: TOP View EMC WRGB SMT Package
- Forward Current: 100/100/100/100mA*
- Forward Voltage (typ.): 3.1/2.3/2.9/3.1V
- Luminous Flux (typ.): 43/16/27/7lm@100mA
- Colour: Cool White/Red/Green/Blue
- **CCT/Wavelength:** 6500K/622/527/461nm
- Viewing Angle: 120°
- **Materials:**

FEATURES:

- Resin: Silicon
- L/T Finish: Ag plated
- Operating Temperature: -40~+70°C
- Storage Temperature: -40~+70°C
- **Grouping Parameters:**
 - Forward Voltage
 - Luminous Flux
 - CCT/Dominant Wavelength
- Soldering Methods: Reflow
- MSL Level: 3 according to J-STD020
- Packing: 8mm tape with max.5000/reel, ø178mm (7")

^{*} in order of White/Red/Green/Blue



CHARACTERISTICS:

Absolute Maximum Characteristics (T_a=25°C)

| Parameter | Symbol | Ratings | Unit |
|--|------------------|--------------------|------|
| DC Forward Current | IF | 150 | mA |
| Pulse Forward Current (width≤100μS; duty≤1/10) | IFP | 225 | mA |
| Power Dissipation | P _D | 525/375/495/525* | mW |
| Reverse Voltage | VR | 5 | V |
| Reverse Current @5V | I _R | 10 | μΑ |
| Junction Temperature | Tj | 110 | °C |
| Operating Temperature | T_{OPR} | -40~+70 | °C |
| Storage Temperature | T _{STG} | -40~+70 | °C |
| Soldering Temperature | T _{SOL} | 230 or 260 for 10S | °C |

^{*} in order of White/Red/Green/Blue

Electrical & Optical Characteristics (T_a=25°C)

| Parameter | Symbol | Values | | | | Test |
|------------------------------|-------------------|------------------|-----------------|-----------------|------|-----------------------|
| Parameter | Зуппол | Min. | Min. Typ. | | Unit | Condition |
| Forward Voltage | VF | 2.9/1.9/2.7/2.9* | 3.1/2.3/2.9/3.1 | 3.5/2.5/3.3/3.5 | V | I _F =100mA |
| Luminous Flux | Ф۷ | 37/13/23/5 | 43/16/27/7 | 47/25/39/12 | lm | I _F =100mA |
| White Colour Temperature | ССТ | | 6500 | | K | I _F =100mA |
| R/G/B Dominant Wavelength | λ_{D} | 617/522/452 | | 626/531/470 | nm | I _F =100mA |
| Viewing Angle | 2θ _{1/2} | | 120 | | deg | I _F =100mA |

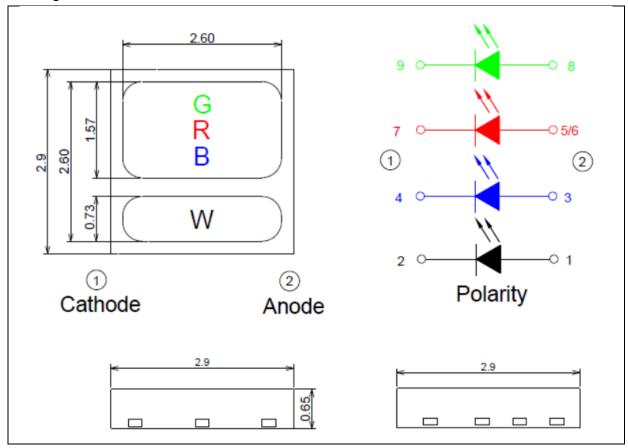
^{1.} Luminous flux (Φ_V) ±10%, Forward Voltage (V_F) ±0.1V

 $^{2. \}hspace{0.5cm} \hbox{* in order of White/Red/Green/Blue} \\$



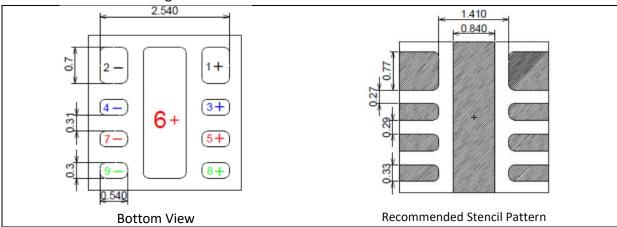
OUTLINE DIMENSION:

Package Dimension:



- 1. All dimensions are in millimetre (mm).
- 2. Tolerance ±0.2mm, unless otherwise noted.

Recommended Soldering Pad Dimension:



- 1. Dimensions are in millimetre (mm).
- 2. Tolerance ±0.1mm with angle tolerance ±0.5°.



BINNING GROUPS:

Forward Voltage Classifications (I_F = 100mA):

| Co | ode | Min. | Max. | Unit |
|-------|-----|------|------|------|
| White | BB1 | 2.9 | 3.5 | V |
| Red | RA1 | 1.9 | 2.5 | V |
| Green | GB1 | 2.9 | 3.5 | V |
| Blue | BB1 | 2.9 | 3.5 | V |

Luminous Flux Classifications (I_F = 100mA):

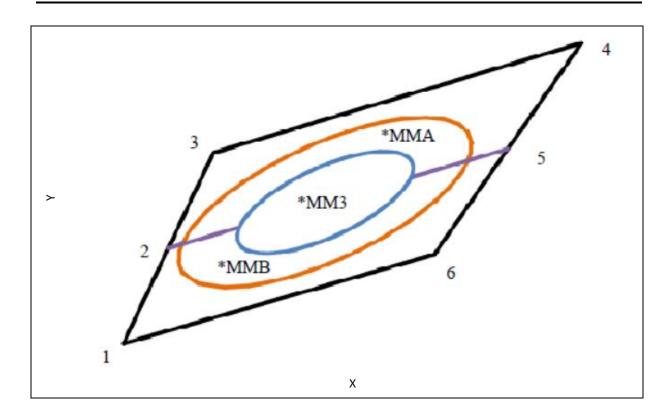
| Co | ode | Min. | Max. | Unit |
|-------|-----|------|------|------|
| White | WN4 | 37 | 47 | lm |
| Dod | RN1 | 13 | 19 | lue |
| Red | RN2 | 19 | 25 | lm |
| Croon | GN1 | 23 | 31 | lm |
| Green | GN2 | 31 | 39 | lm |
| Blue | BN2 | 5 | 12 | lm |

Dominant Wavelength Classifications (IF = 100mA):

| Code | | Min. | Max. | Unit |
|-------|-----|------|------|------|
| | RE1 | 617 | 620 | |
| Red | RE2 | 620 | 623 | nm |
| | RE3 | 623 | 626 | |
| | GE2 | 522 | 525 | |
| Green | GE3 | 525 | 528 | nm |
| | GE4 | 528 | 531 | |
| | BE2 | 452 | 455 | |
| | BE3 | 455 | 458 | |
| Dlug | BE4 | 458 | 461 | |
| Blue | BE5 | 461 | 464 | nm |
| | BE6 | 464 | 467 | |
| | BE7 | 467 | 470 | |



CIE CHROMATICITY DIAGRAM:



Chromaticity Coordinates Classifications (IF = 100mA):

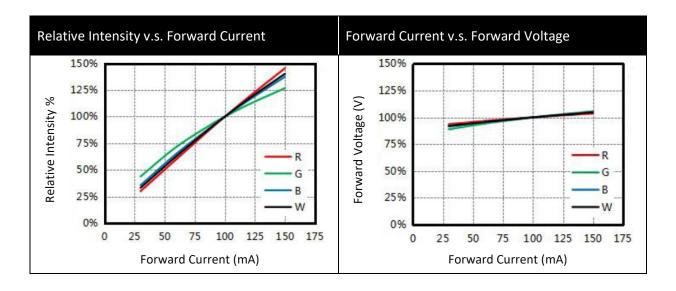
| | Codo | Cer | ntre | Rac | dius | Angle |
|--------|-----------|--------|--------|----------|----------|-------|
| Φ | Code | Х | Υ | а | b | Ф |
| | 1MM-3STEP | 0.3130 | 0.3290 | 0.006690 | 0.002850 | 58.34 |
| | 1MM-5STEP | 0.3130 | 0.3290 | 0.011150 | 0.004750 | 58.34 |

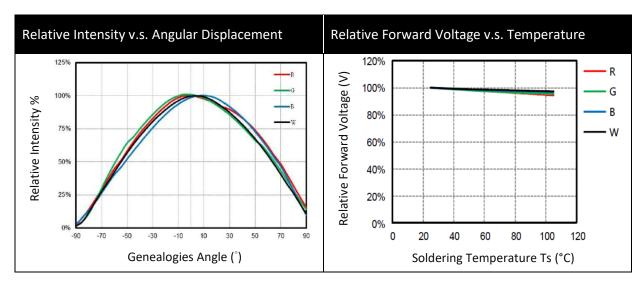
Chromaticity Coordinates Classifications ($I_F = 20mA$):

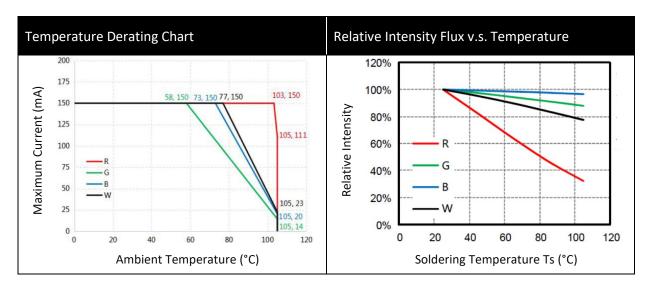
| | 1 | 1 | 2 | 2 | 3 | 3 | 2 | 1 |
|------|--------|--------|--------|--------|--------|--------|--------|--------|
| | Х | Υ | Х | Y | Х | Υ | Х | Υ |
| 1256 | 0.3075 | 0.3121 | 0.3055 | 0.3217 | 0.3220 | 0.3379 | 0.3228 | 0.3269 |
| 2345 | 0.3055 | 0.3217 | 0.3035 | 0.3312 | 0.3212 | 0.3489 | 0.3220 | 0.3379 |



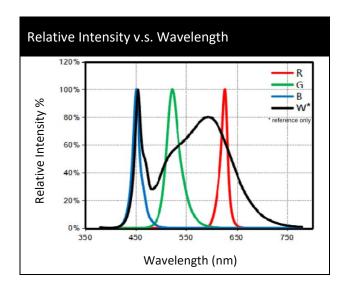
ELECTRO-OPTICAL CHARACTERISTICS:







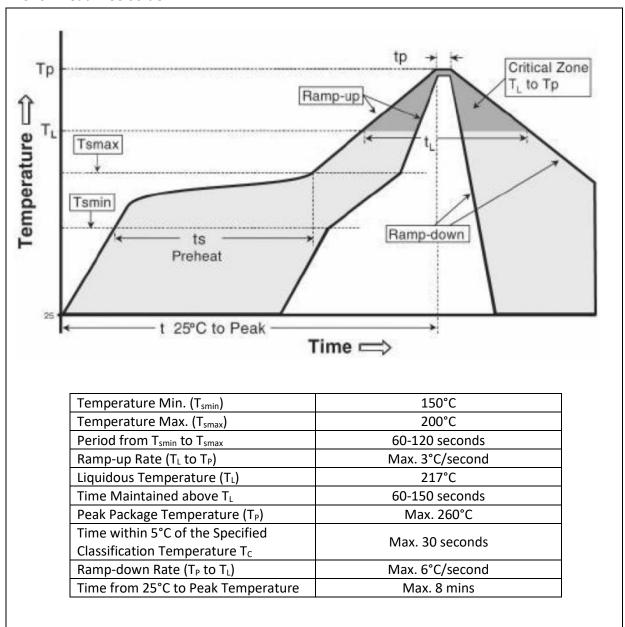






RECOMMENDED SOLDERING PROFILE:

Reflow Lead-free Solder:



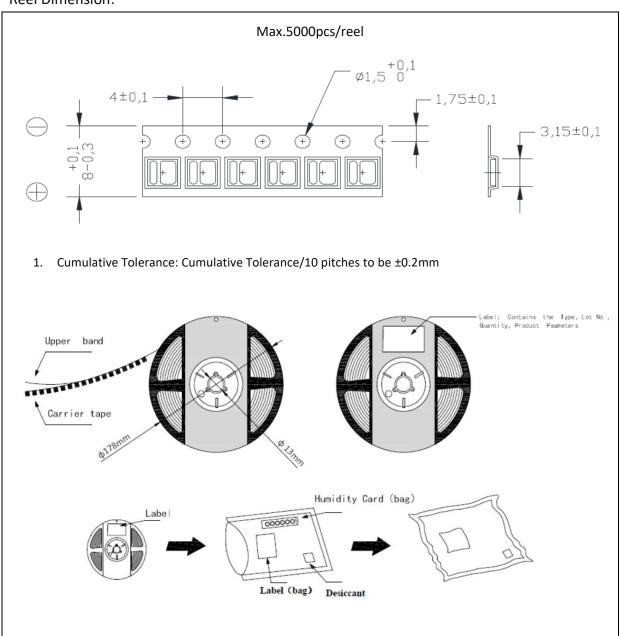
Note:

- 1. Die slug is to be soldered.
- 2. Maximum reflow soldering: 2 times. Between two soldering it should not be longer than 24 hours.
- 3. Before, during, and after soldering, should not apply stress on the components and PCB board.
- 4. Recommended soldering temperature: 240°C. The maximum soldering temperature should be limited to 260°C for max. 10seconds.



PACKING SPECIFICATION:

Reel Dimension:





PRECAUTIONS OF USE:

Storage:

It is recommended to store the products in the following conditions:

- Humidity: 60% R.H. Max.
- Temperature: 5°C~30°C (41°F ~86°F).

Shelf life in sealed bag: 12 months at 5°C~30°C and <60% R.H.

Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a damp-proof box with descanting agent <10% R.H. and apply baking before use.

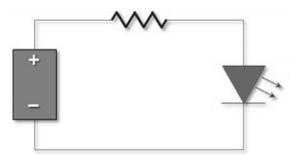
Baking:

It is recommended to bake the LED before soldering if the pack has been unsealed for longer than 24hrs. The suggested baking conditions are as followings:

60±5°C x 24hrs and <5%RH, taped / reel package.

It's normal to see slight color fading of carrier (light yellow) after baking in process.

Testing Circuit:



Must apply resistor(s) for protection (over current proof).

Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED carrier / package. Avoid putting any stress force directly on to the LED lens.

ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrosatic glove is recommended when handing the LED all time. All devices, equipment, machinery, work tables, and storage racks must be properly grounded.

In the events of manual working in process, make sure the devices are well protected from ESD at any time.



REVISION RECORD:

| Version | Date | Summary of Revision |
|---------|------------|---|
| A1.0 | 04/09/2022 | Datasheet set-up. |
| A1.1 | 13/02/2025 | Update sorting current to 100mA and add characteristics curves. |